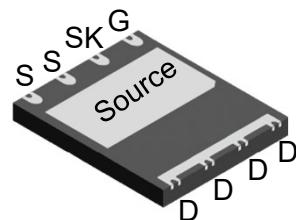


## Description

Product Summary		
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (mΩ)(Typ)	I <sub>D</sub> (A)
700	240	6.5

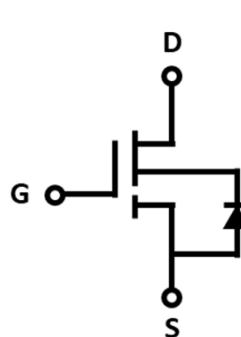
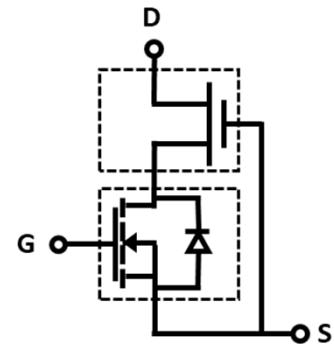

**DFN5×6 (Bottom View)**

## Feature

- Easy to use, compatible with standard gate drivers
- Excellent Q<sub>G</sub> × R<sub>DS(on)</sub> figure of merit (FOM)
- Low Q<sub>RR</sub>, no free-wheeling diode required
- Low switching loss
- RoHS compliant and Halogen-free

## Applications

- High efficiency power supplies
- Telecom and datacom
- Automotive
- Servo motors


**Schematic Symbol**

**Cascode  
Device Structure**

## Absolute maximum rating@25°C

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	700	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Transient Drain-Source Voltage <sup>1)</sup>	V <sub>TDS</sub>	800	V
Continuous Drain Current	I <sub>D</sub>	6.5	A
		4	
Pulsed Drain Current (Pulse Width: 100μs)	I <sub>DM</sub>	19	A
		15	
Power Dissipation	P <sub>D</sub>	19	W
Soldering Peak Temperature	T <sub>CSOLD</sub>	260	°C
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

## Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	-	6.5	-	°C/W
Thermal Resistance, Junction-to-Ambient <sup>2)</sup>	R <sub>θJA</sub>	-	50	-	°C/W

# 700V GaN Power Transistor

PGC8N70R240BL

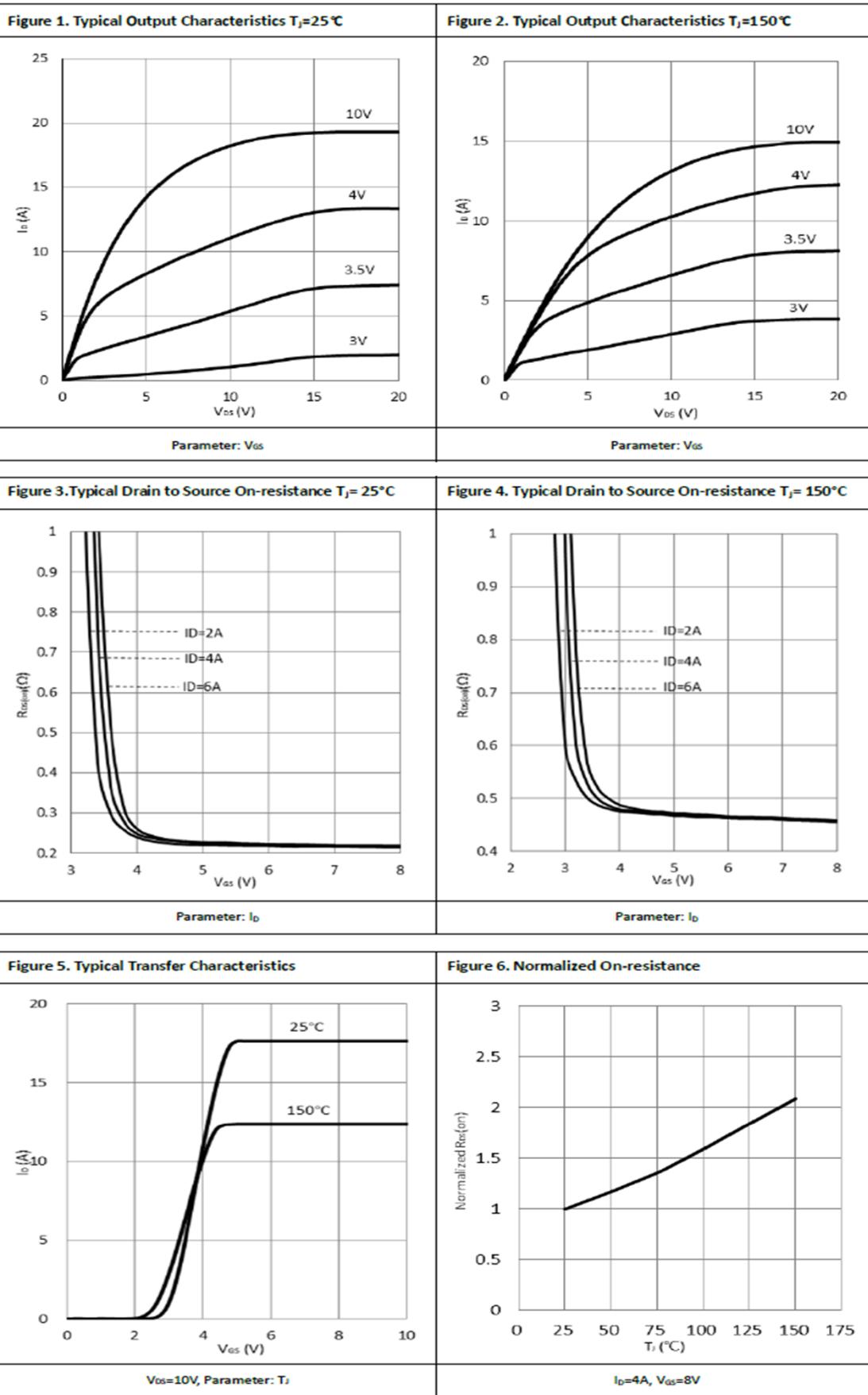
## Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
<b>Statistic Characteristics</b>						
Maximum Drain-Source Voltage	V <sub>DS-Max</sub>	V <sub>GS</sub> = 0V	700	-	-	V
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA	-	1000	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =700V, V <sub>GS</sub> =0V	T <sub>J</sub> =25°C	-	8	20
			T <sub>J</sub> =150°C	-	50	-
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V	-	-	±150	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 500µA	1.1	1.8	2.5	V
Drain-Source On-State Resistance <sup>3)</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> =8V, I <sub>D</sub> =4A	T <sub>J</sub> =25°C	-	240	300
			T <sub>J</sub> =150°C	-	480	-
<b>Dynamic Characteristics</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 400V, V <sub>GS</sub> = 0V, f = 1MHz	-	289	-	pF
Output Capacitance	C <sub>oss</sub>		-	16	-	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	0.6	-	
Effective Output Capacitance, Energy Related	C <sub>o(er)</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0-400V	-	24	-	pF
Effective Output Capacitance, Time Related	C <sub>o(tr)</sub>		-	66	-	
Output Charge	Q <sub>oss</sub>		-	27	-	nC
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DS</sub> = 400V, I <sub>D</sub> = 4A, V <sub>GS</sub> = 0-8V, R <sub>G</sub> = 47Ω	-	28	-	ns
Turn-on Rise Time	t <sub>r</sub>		-	14	-	
Turn-Off Delay Time	t <sub>d(off)</sub>		-	108	-	
Turn-Off Fall Time	t <sub>f</sub>		-	8	-	
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 400V, I <sub>D</sub> = 4A, V <sub>GS</sub> = 0-8V	-	5.6	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	1.5	-	
Gate-Drain Charge	Q <sub>gd</sub>		-	2	-	
<b>Reverse Diode Characteristics</b>						
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =2A	-	1.3	-	V
		V <sub>GS</sub> =0V, I <sub>S</sub> =4A	T <sub>J</sub> =25°C	-	1.8	
			T <sub>J</sub> =150°C	-	2.7	
Reverse Recovery Time	t <sub>rr</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =4A, V <sub>DD</sub> =400V, di/dt=1000A/µs	-	16	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>		-	27	-	µC

### Notes:

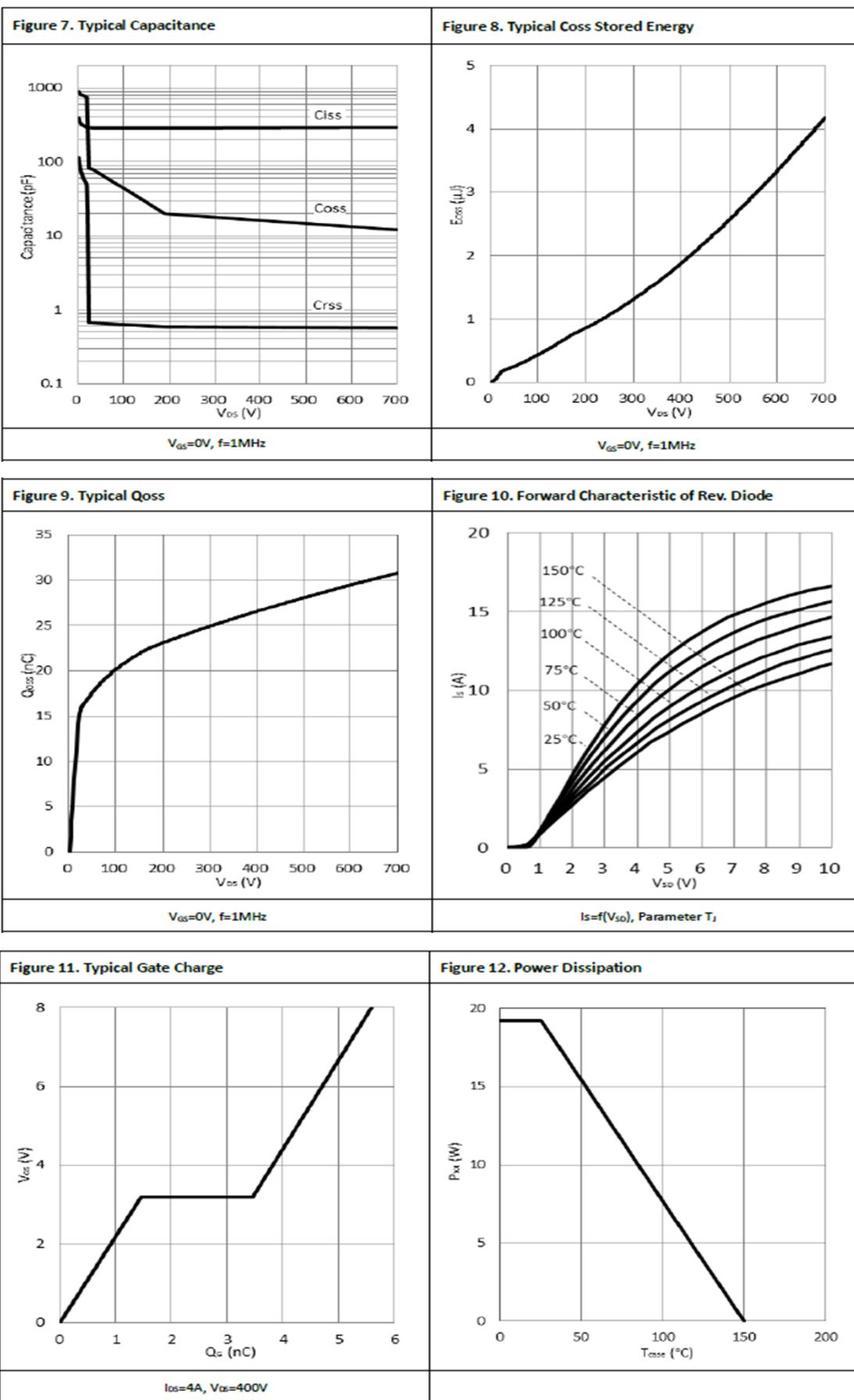
1. Off-state spike duty cycle < 0.01, spike duration < 2µs
2. Device on one layer epoxy PCB for drain connection (vertical and without air stream cooling, with 6cm<sup>2</sup>copper area and 70µm thickness)
3. Dynamic on-resistance; see Figure 19 and 20 for test circuit and configurations

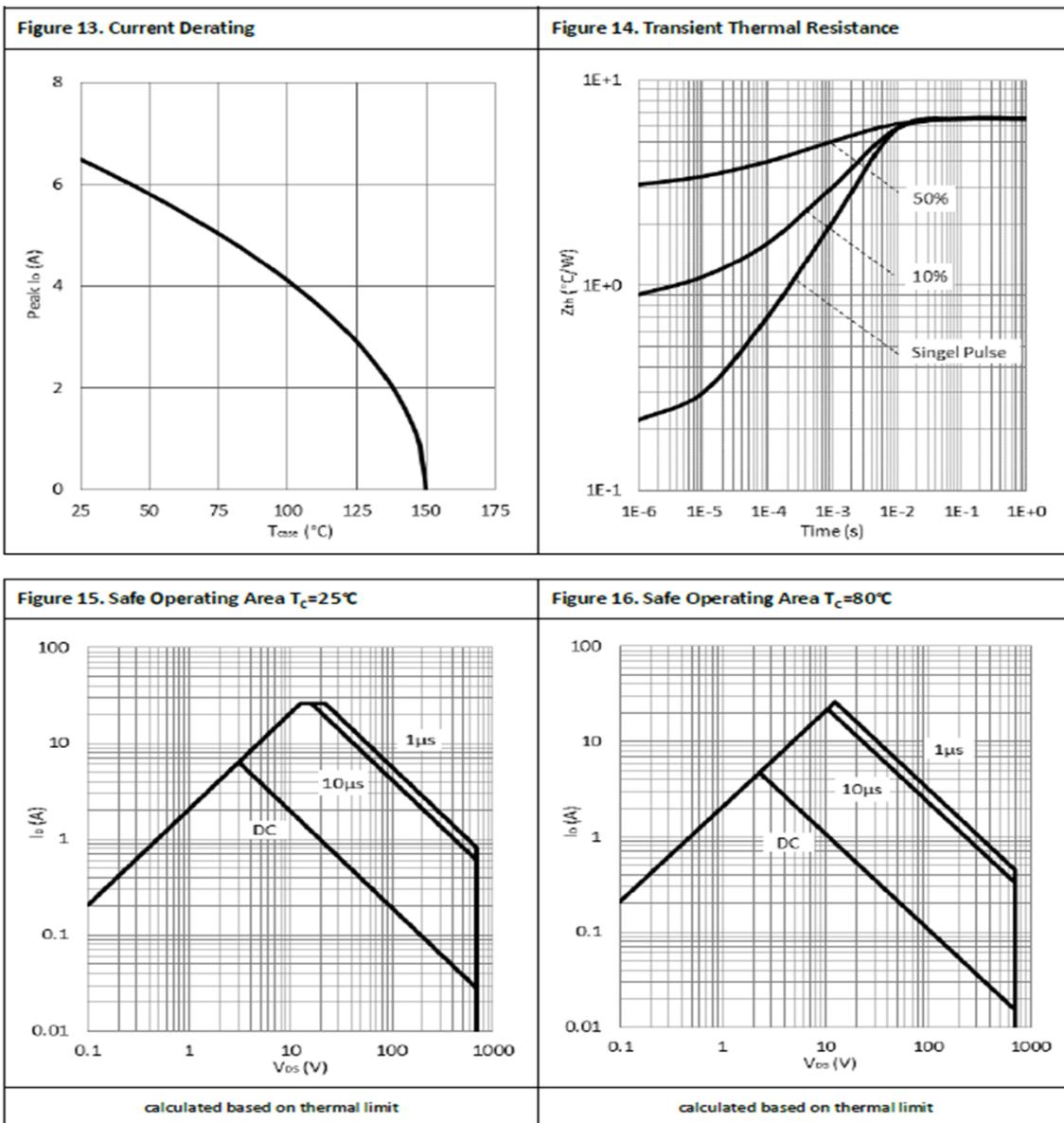
## Typical Characteristics



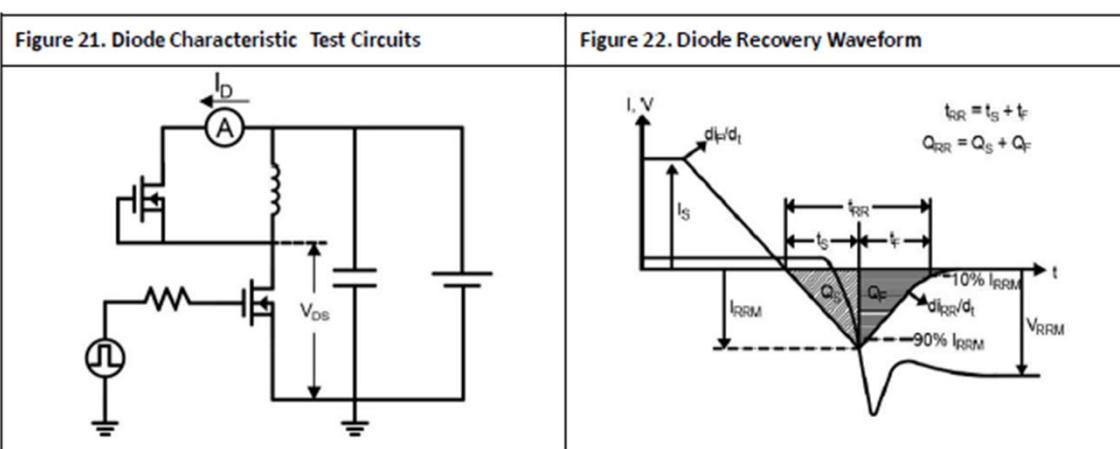
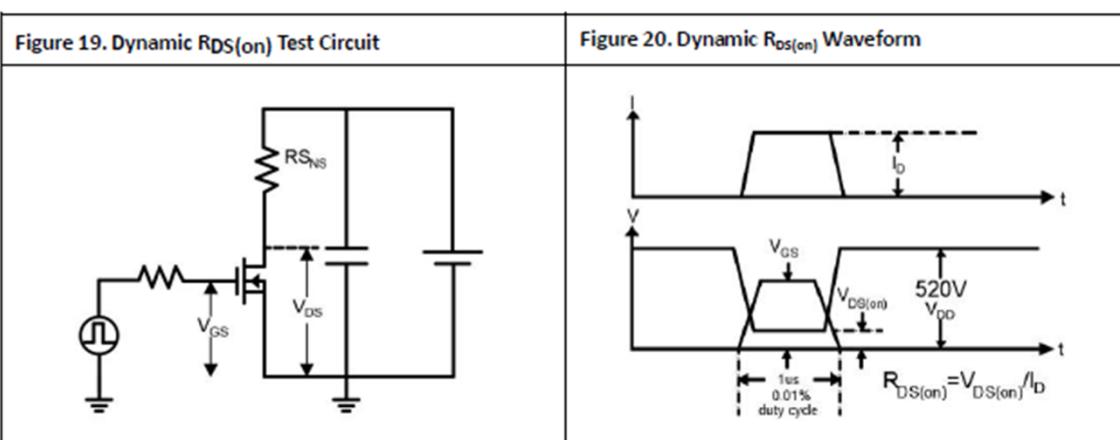
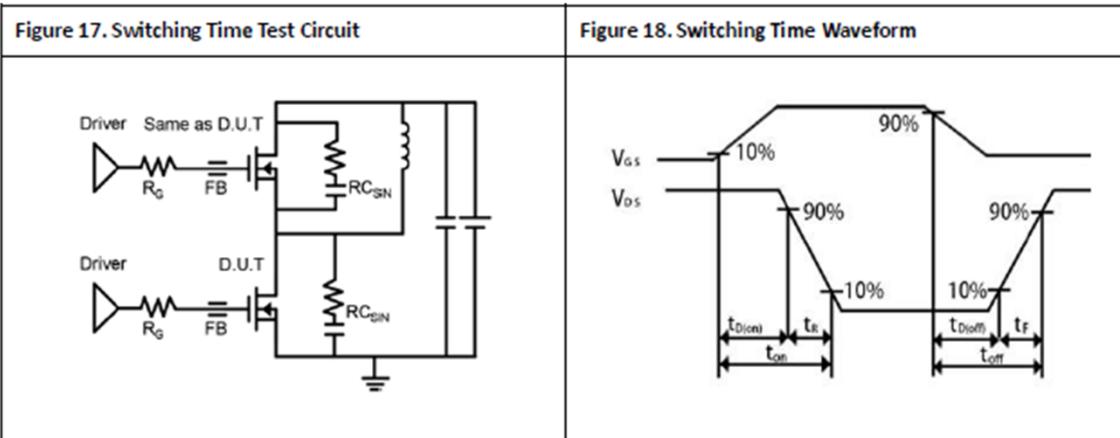
# 700V GaN Power Transistor

PGC8N70R240BL

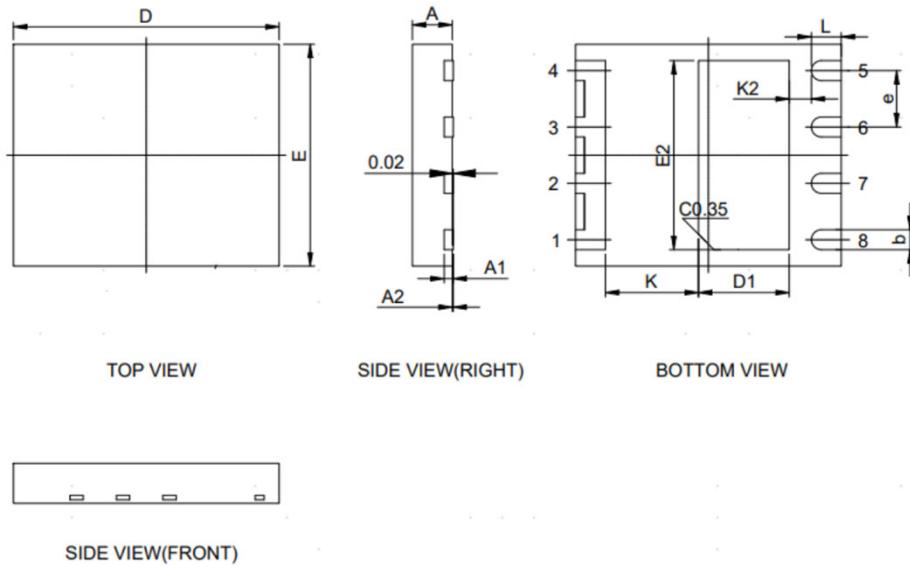




## Test Circuits and Waveforms



## Product Dimension (DFN5×6)



SYMBOL	Millimeter		
	Min	Nom	Max
A	0.80	0.90	1.00
A1	0.203REF.		
A2	0	0.02	0.05
b	0.40	0.45	0.50
D	5.90	6.00	6.10
D1	1.95	2.05	2.15
e	1.27BSC		
E	4.90	5.00	5.10
E2	4.16	4.26	4.36
L	0.625	0.675	0.725
K	2.10REF.		
K2	0.50REF.		

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